

Temperature Rise Data

Product High Power Chip Resist	ors <wid< th=""><th>e Terminal typ</th><th>e><anti-surge></anti-surge></th><th>Series</th><th>LTR series</th><th>Туре</th><th>LTR18 EZP</th><th>Rated Power</th><th>1.5W</th></wid<>	e Terminal typ	e> <anti-surge></anti-surge>	Series	LTR series	Туре	LTR18 EZP	Rated Power	1.5W
Test conditions Ambient temperature: Board specifications Cu foil thickness Number of layers of Cu foil Sample size Direct current application	温度上昇(°C) : : : : : : : : : : : : : : : : : : :	4 t = 1.6 mm m	Sample siz	mperature: cifications kness layers of Cu foil e ent application Thot spot Terminal 2Hot spot	: 3pcs		100 (1.5W)	Hot spot Termi	nal

[Caution]

This data is the value of specific lot and specific resistance value only. It does not guarantee the variations due to different lot and product.

This data is not guaranteed. This data shall be utilized as reference data of the actual product characteristic.

When deciding the usage of the product, we cordially ask you not to only rely on this data but to have own evaluation and verification.

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